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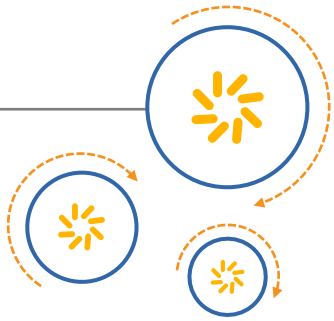

SAW Components

SAW Tx filter

Automotive telematics

Series/type:	B4334
Ordering code:	B39711B4334P810
Date:	August 12, 2014
Version:	2.0

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RF360 Europe GmbH, Anzinger Str. 13, München, Germany

SAW Components

SAW Tx filter

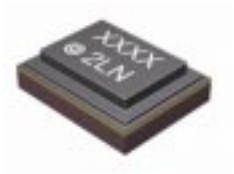
Automotive telematics

Series/type:	**B4334**
Ordering code:	**B39711B4334P810**
Date:	August 12, 2014
Version:	2.0

EPCOS AG is a TDK Group Company.

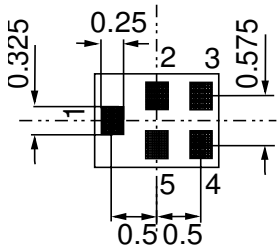
Application

- Low-loss RF filter for LTE Band 17 systems (Tx)
- No matching network required for operation at 50 Ω
- Usable passband 12 MHz

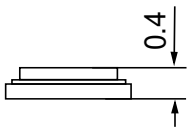


Features

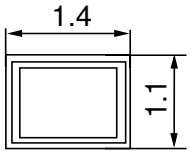
- Package size 1.4 x1.1 x 0.4 mm³
- Package code QCS5P
- RoHS compatible
- Approximate weight 0.003 g
- Package for **S**urface **M**ount **T**echnology (**SMT**)
- Ni, gold-plated terminals
- AEC-Q200 qualified component family (operable temperature range -40˚C to +85˚C)
- **E**lectrostatic **S**ensitive **D**evice (**ESD**)



bottom view



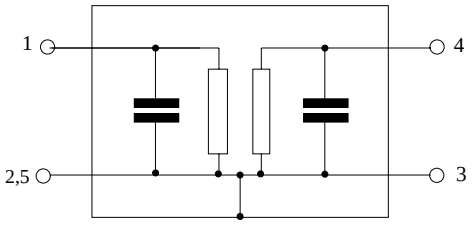
side view



top view

Pin configuration

- 1 Input
- 4 Output
- 2,3,5 To be grounded



Data sheet SMD

Characteristics

Temperature range for specification: T = –30 ˚C to +85 ˚C
Terminating source impedance: Z_S = 50 Ω
Terminating load impedance: Z_L = 50 Ω

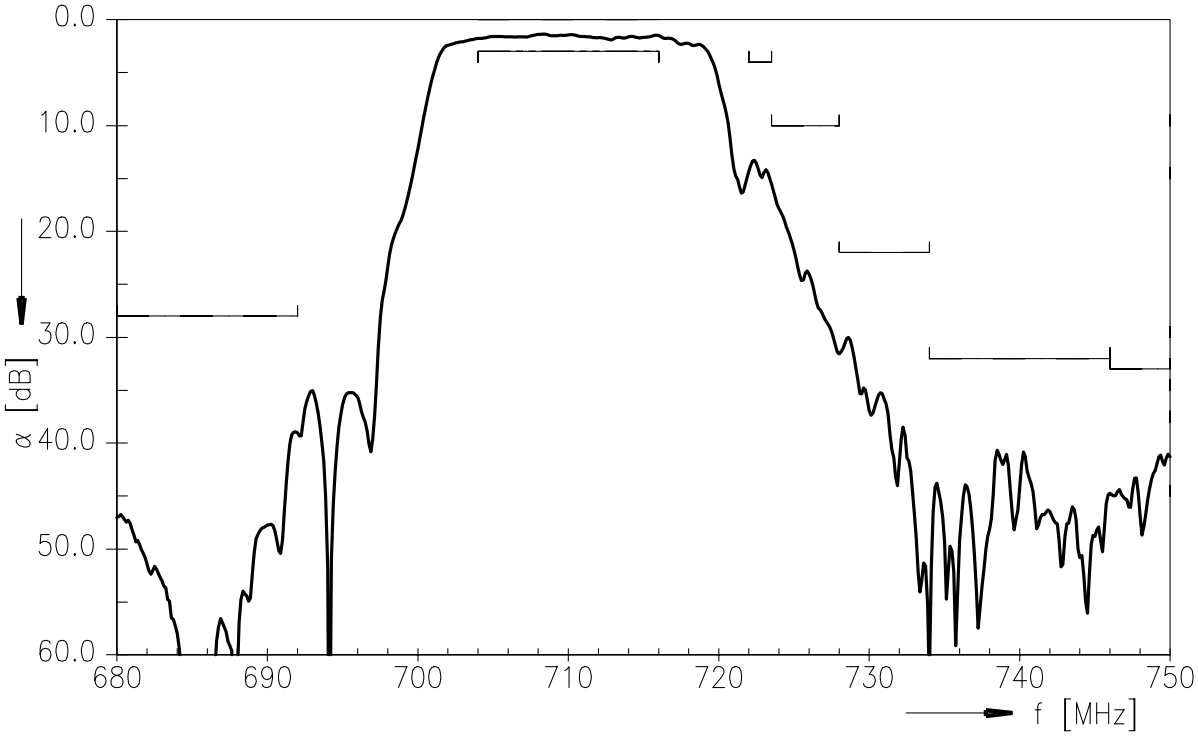
		min.	typ. @ 25˚C	max.	
Center frequency	f_C	—	710.0	—	MHz
Maximum insertion attenuation	α_{max}				
704.0 ... 716.0 MHz		—	2.1	3.0 [1]	dB
Amplitude ripple (p-p)	$\Delta\alpha$				
704.0 ... 716.0 MHz		—	0.7	2.2	dB
Input VSWR					
704.0 ... 716.0 MHz		—	1.8	2.0	
Output VSWR					
704.0 ... 716.0 MHz		—	1.7	2.0	
Attenuation	α				
50.0 ... 692.0 MHz		28	38	—	dB
722.0 ... 723.5 MHz		4	13	—	dB
723.5 ... 728.0 MHz		10	15	—	dB
728.0 ... 734.0 MHz		22	30	—	dB
734.0 ... 746.0 MHz		32	40	—	dB
746.0 ... 805.0 MHz		33	40	—	dB
869.0 ... 894.0 MHz		35	60	—	dB
1408.0 ... 1432.0 MHz		30	55	—	dB
1565.0 ... 1607.0 MHz		45	53	—	dB
1805.0 ... 1990.0 MHz		30	48	—	dB
2110.0 ... 2170.0 MHz		38	44	—	dB
2400.0 ... 2484.0 MHz		35	45	—	dB
2816.0 ... 2864.0 MHz		15	36	—	dB
3000.0 ... 6000.0 MHz		10	20	—	dB

[1] 2.8dB for reduced in temperature range -10 ˚C to +70 ˚C

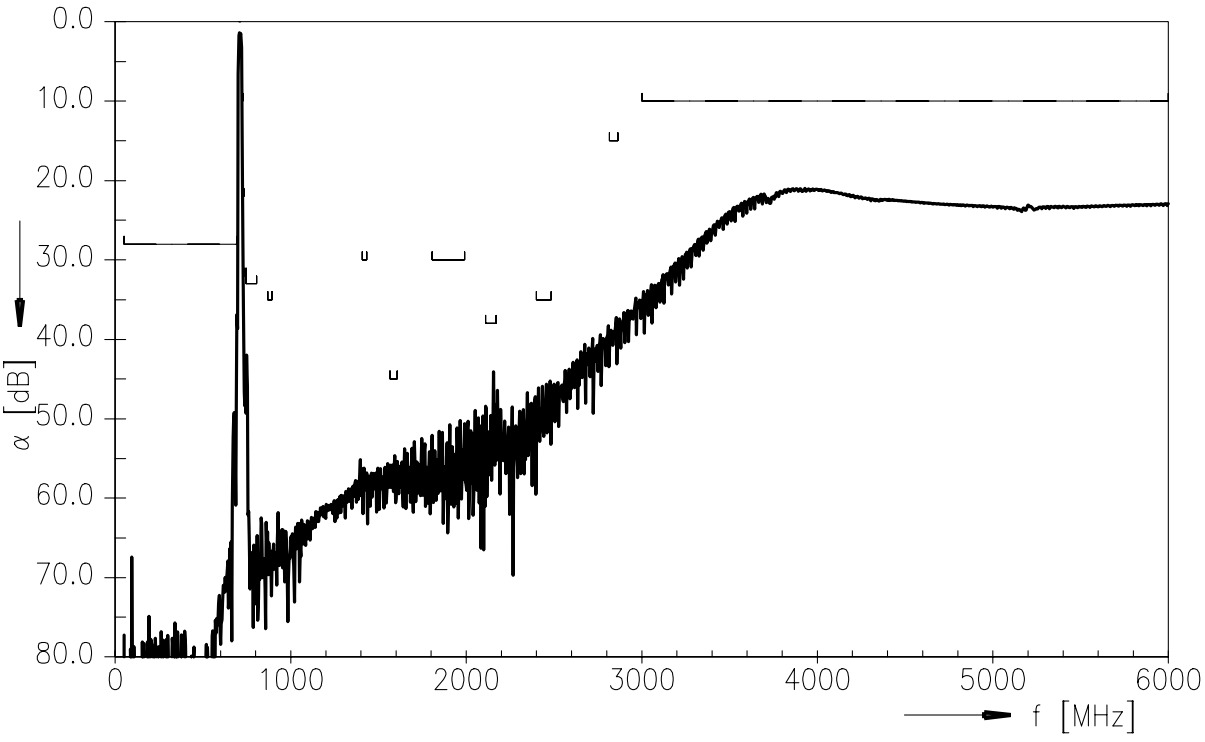
Maximum ratings

Operable temperature range	T	–40/+85	˚C	
Storage temperature range	T_{stg}	–40/+85	˚C	
DC voltage	V_{DC}	0	V	
Input Power at 704.0 ... 716.0 MHz	P_{IN}	20	dBm	CW signal for 2000h at T = 50 ˚C

Transfer function

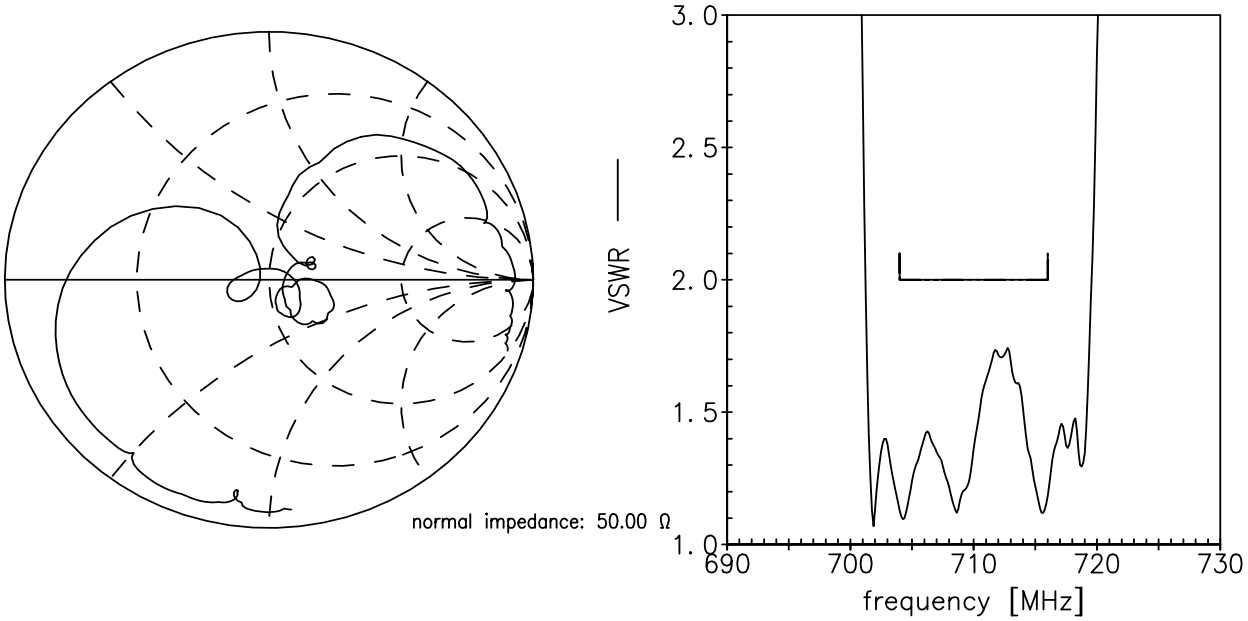


Transfer function (wideband)

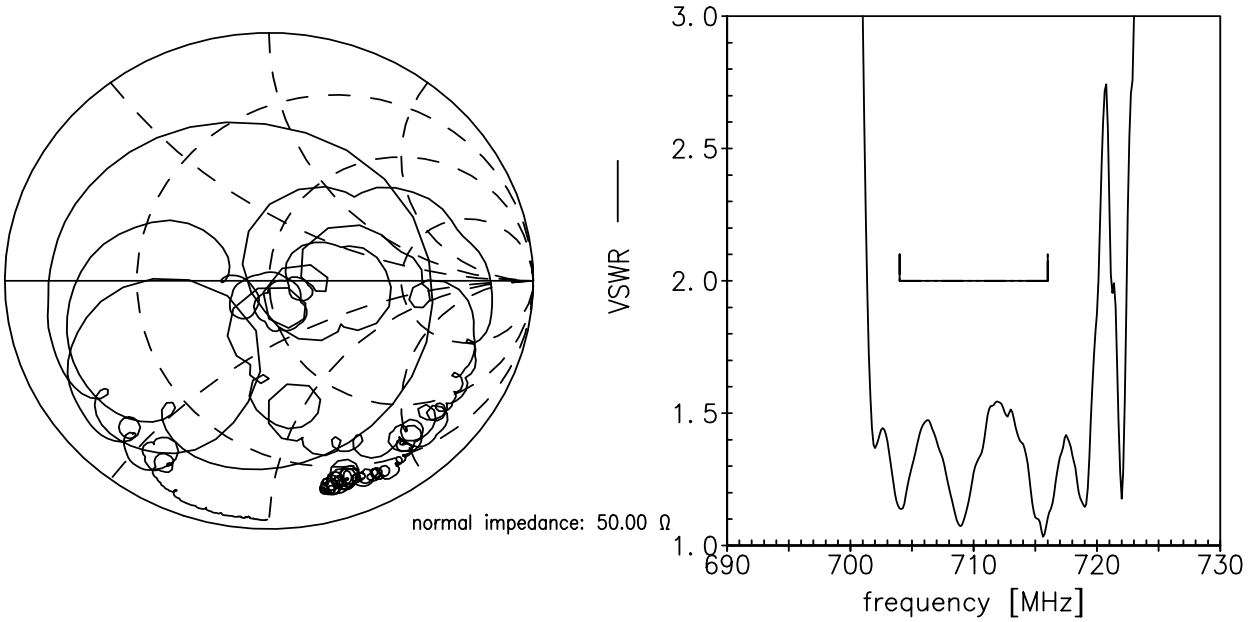


Smith chart

S_{11} function



S_{22} function



ESD protection of SAW filters

SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.
In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wideband filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

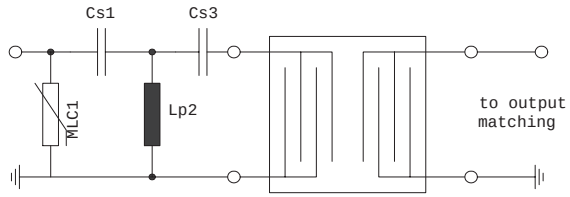


Fig. 1 MLC varistor plus ESD matching

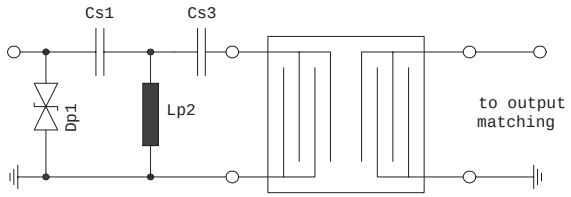


Fig. 2 Suppressor diode plus ESD matching

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.

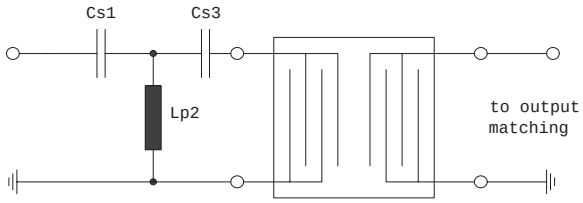


Fig. 3 3rd order high-pass structure for basic ESD protection

In all three figures the shunt inductor Lp2 could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available pcb space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements

For further information, please refer to EPCOS Application report:
“**ESD protection for SAW filters**”.
This report can be found under www.epcos.com/rke.Click on “Applications Notes”.

References

Type	B4334
Ordering code	B39711B4334P810
Marking and package	C61157-A8-A9
Packaging	F61074-V8237-Z000
Date codes	L_1126
S-parameters	B4334_NB.s2p, B4334_WB.s2p see file header for port/pin assignment table
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm for a large variety of matching coils.

For further information please contact your local EPCOS sales office or visit our webpage at www.epcos.com .

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